This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1-18 (cancelled)

- 1 19. (currently amended): A thin film device comprising:
- 2 at least one thin film layer;
- at least one electrochemically plated component; said component including a central
- 4 portion that projects generally upwardly from said thin film layer; said component being formed
- 5 with an overplated head that includes overhang portions, wherein said overhang portions project
- 6 generally laterally outward from said central portion and over said thin film layer, and wherein
- 7 said overhang portions include an outer edge thereof;
- 8 hard baked photoresist being disposed beneath said overhang portions to fill an area
- 9 beneath said overhang portions; said photoresist being disposed within a volume defined by said
- thin film layer, said central portion of said component, said overhang portions, and a surface that
- is generally perpendicular to said thin film layer and which surface intersects said outer edge of
- said overhang portion.
- 1 20. (previously presented): A thin film device as described in claim 19 wherein said
- 2 component is formed by electrochemically plating into an opening formed in a photoresist layer
- 3 using photolithographic process techniques.

- 1 21. (original): A thin film device as described in claim 19 wherein said device is a thin film
- 2 magnetic head.
- 1 22. (original): A thin film device as described in claim 21 wherein said component is a yoke
- 2 portion of a magnetic pole.
- 1 23. (previously presented): A thin film device as described in claim 22 wherein said yoke
- 2 portion is formed with straight sided pole tip portions and overplated yoke portions.
- 3 24. (original): A thin film device as described in claim 19 wherein said component is an
- 4 electrical interconnecting stud.
- 1 25. (currently amended): A hard disk drive, comprising:
- at least one hard disk being adapted for rotary motion upon a drive device;
- at least one slider device having a slider body portion being adapted to fly over said hard
- 4 disk; a magnetic head being formed on slider body for writing data on said hard disk; said
- 5 magnetic head including:
- 6 at least one thin film layer;
- 7 at least one electrochemically plated component; said component including a central
- 8 portion that projects generally upwardly from said thin film layer; said component being formed
- 9 with an overplated head that includes overhang portions, wherein said overhang portions project
- generally laterally outward from said central portion and over said thin film layer, and wherein
- said overhang portions include an outer edge thereof;

- hard baked photoresist being disposed beneath said overhang portions to fill an area

 beneath said overhang portions; said photoresist being disposed within a volume defined by said

 thin film layer, said central portion of said component, said overhang portions, and a surface that

 is generally perpendicular to said thin film layer and which surface intersects said outer edge of
- said overhang portion.
- 1 26. (previously presented): A hard disk drive as described in claim 25 wherein said
- 2 component is formed by electrochemically plating into an opening formed in a photoresist layer
- 3 using photolithographic process techniques.
- 1 27. (cancelled):
- 1 28. (original): A hard disk drive as described in claim 27 wherein said component is a yoke
- 2 portion of a magnetic pole.
- 1 29. (previously presented): A hard disk drive as described in claim 28 wherein said yoke
- 2 portion is formed with straight sided pole tip portions and overplated yoke portions.
- 1 30. (original): A hard disk drive as described in claim 25 wherein said component is an
- 2 electrical interconnecting stud.